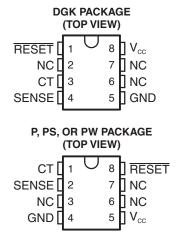


# SUPPLY-VOLTAGE SUPERVISOR

#### **FEATURES**

- Adjustable Sense Voltage With Two External Resistors
- · Adjustable Hysteresis of Sense Voltage
- Wide Operating Supply-Voltage Range: 1.8 V to 40 V
- Wide Operating Temperature Range: -40°C to 85°C
- Low Power Consumption:
  I<sub>CC</sub> = 0.6 mA Typ, V<sub>CC</sub> = 40 V
- Minimum External Components
- Now Available in MSOP (DGK) package



NC - No internal connection

#### **DESCRIPTION/ORDERING INFORMATION**

The TL7700 is a bipolar integrated circuit designed for use as a reset controller in microcomputer and microprocessor systems. The SENSE voltage can be set to any value greater than 0.5 V using two external resistors. The hysteresis value of the sense voltage also can be set by the same resistors. The device includes a precision voltage reference, fast comparator, timing generator, and output driver, so it can generate a power-on reset signal in a digital system.

The TL7700 has an internal 1.5-V temperature-compensated voltage reference from which all function blocks are supplied. Circuit function is very stable, with supply voltage in the 1.8-V to 40-V range. Minimum supply current allows use with ac line operation, portable battery operation, and automotive applications.

#### ORDERING INFORMATION(1)

T <sub>A</sub>	PACK	AGE <sup>(2)</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	PDIP – P	Tube of 50	TL7700CP	TL7700CP	
	SOP - PS	Reel of 2000	TL7700CPSR	T7700	
–40°C to 85°C	TSSOP – PW	Tube of 150 TL7700CPW		T7700	
-40 C to 65 C		Reel of 2000	TL7700CPWR	17700	
	MSOP – DGK	Reel of 250	TL7700CDGKT	9TS	
		Reel of 2500	TL7700CDGKR	913	

<sup>(1)</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

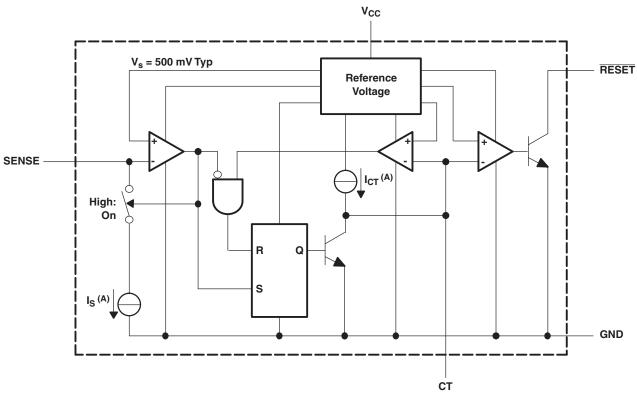


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

<sup>(2)</sup> Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.



#### **FUNCTIONAL BLOCK DIAGRAM**



A.  $I_{CT} = 15 \mu A \text{ (Typ)}, I_s = 2.5 \mu A \text{ (Typ)}$ 

#### **TERMINAL FUNCTIONS**

	TERMINAL		DESCRIPTION				
NAME	NO.		DESCRIPTION				
NAIVIE	P, PS, PW	DGK					
СТ	1	3	Timing capacitor connection. This terminal sets the RESET output pulse duration ( $t_{po}$ ). It is connected internally to a 15- $\mu$ A constant-current source. There is a limit on the switching speed of internal elements; even if CT is set to 0, response speeds remain at approximately 5 to 10 $\mu$ s. If CT is open, the device can be used as an adjustable-threshold noninverting comparator. If CT is low, the internal output-stage comparator is active, and the RESET output transistor is on. An external voltage must not be applied to this terminal due to the internal structure of the device. Therefore, drive the device using an open-collector transistor, FET, or 3-state buffer (in the low-level or high-impedance state).				
GND	4	5	Ground. Keep this terminal as low impedance to reduce circuit noise.				
NC	3, 6, 7	2, 6, 7	No internal connection				
RESET	8	1	Reset output. This terminal can be connected directly to a system that resets in the active-low state. A pullup resistor usually is required because the output is an npn open-collector transistor. An additional transistor should be connected when the active-high reset or higher output current is required.				
SENSE	2	4	Voltage sense. This terminal has a threshold level of 500 mV. The sense voltage and hysteresis can be set at the same time when the two voltage-dividing resistors are connected. The reference voltage is temperature compensated to inhibit temperature drift in the threshold voltage within the operating temperature range.				
V <sub>CC</sub>	5	8	Power supply. This terminal is used in an operating-voltage range of 1.8 V to 40 V.				



#### ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

$V_{CC}$	Supply voltage <sup>(2)</sup>	41 V	
Vs	Sense input voltage range	–0.3 V to 41 V	
V <sub>OH</sub>	Output voltage (off state)	41 V	
I <sub>OL</sub>	Output current (on state)		5 mA
		P package	85°C/W
0	Decke so the small impedance (3) (4)	PS package	95°C/W
$\theta_{JA}$	Package thermal impedance (3) (4)	PW package	149°C/W
		DGK package	172°C/W
$T_J$	Operating virtual-junction temperature	150°C	
T <sub>stg</sub>	Storage temperature range	-65°C to 150°C	

<sup>(1)</sup> Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

All voltage values are with respect to the network ground terminal.

#### RECOMMENDED OPERATING CONDITIONS

		MIN	MAX	UNIT
$V_{CC}$	Supply voltage	1.8	40	V
I <sub>OL</sub>	Low-level output current		3	mA
T <sub>A</sub>	Operating free-air temperature	-40	85	°C

#### **ELECTRICAL CHARACTERISTICS**

V<sub>CC</sub> = 3 V (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	T <sub>A</sub>	MIN	TYP	MAX	UNIT
V	CENCE input valtage		25°C	495	500	505	~^\
Vs	SENSE input voltage		-40°C to 85°C	490		510	mV
L CENCE input ourset		V <sub>s</sub> = 0.4 V	25°C	2	2.5	3	^
I <sub>s</sub> SENSE input current	SENSE input current	V <sub>S</sub> = 0.4 V	-40°C to 85°C	1.5		3.5	μΑ
Icc	Supply current	$V_{CC} = 40 \text{ V}, V_s = 0.6 \text{ V}, \text{ No load}$	25°C		0.6	1	mA
V	Low level output voltage	I <sub>OL</sub> = 1.5 mA	25°C			0.4	<b>V</b>
V <sub>OL</sub>	Low-level output voltage	I <sub>OL</sub> = 3 mA	25°C			8.0	V
I <sub>OH</sub>	High-level output current	V <sub>OH</sub> = 40 V, V <sub>s</sub> = 0.6 V	-40°C to 85°C			1	μΑ
I <sub>CT</sub>	Timing-capacitor charge current	V <sub>s</sub> = 0.6 V	25°C	11	15	19	μΑ

### **SWITCHING CHARACTERISTICS**

 $V_{CC} = 3 \text{ V}, T_A = 25^{\circ}\text{C}$  (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t <sub>pi</sub>	SENSE pulse duration	$C_T = 0.01 \mu F$	2			μs
t <sub>po</sub>	Output pulse duration	C <sub>T</sub> = 0.01 μF	0.5	1	1.5	ms
t <sub>r</sub>	Output rise time	$C_T = 0.01 \mu F, R_L = 2.2 k\Omega, C_L = 100 pF$			15	μs
t <sub>f</sub>	Output fall time	$C_T = 0.01 \mu F$ , $R_L = 2.2 k\Omega$ , $C_L = 100 pF$			0.5	μs
t <sub>pd</sub>	Propagation delay time, SENSE to output	C <sub>T</sub> = 0.01 μF			10	μs

Product Folder Link(s): TL7700

Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(max) - T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can impact reliability. The package thermal impedance is calculated in accordance with JESD 51-7.



### PARAMETER MEASUREMENT INFORMATION

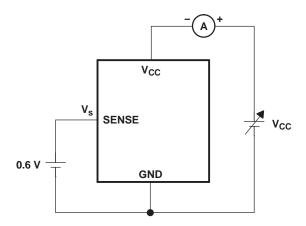


Figure 1. V<sub>CC</sub> vs I<sub>CC</sub> Measurement Circuit

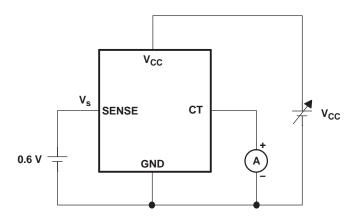


Figure 2.  $V_{CC}$  vs  $I_{CT}$  Measurement Circuit

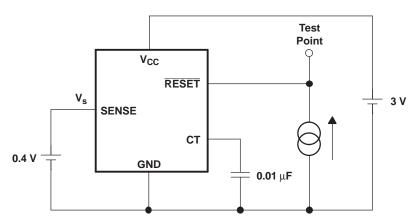


Figure 3.  $I_{OL}$  vs  $V_{OL}$  Measurement Circuit



# PARAMETER MEASUREMENT INFORMATION (continued)

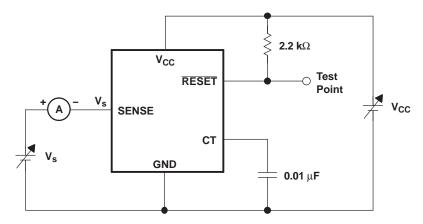


Figure 4.  $V_s$ ,  $I_s$  Characteristics Measurement Circuit

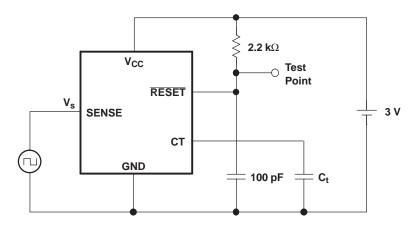


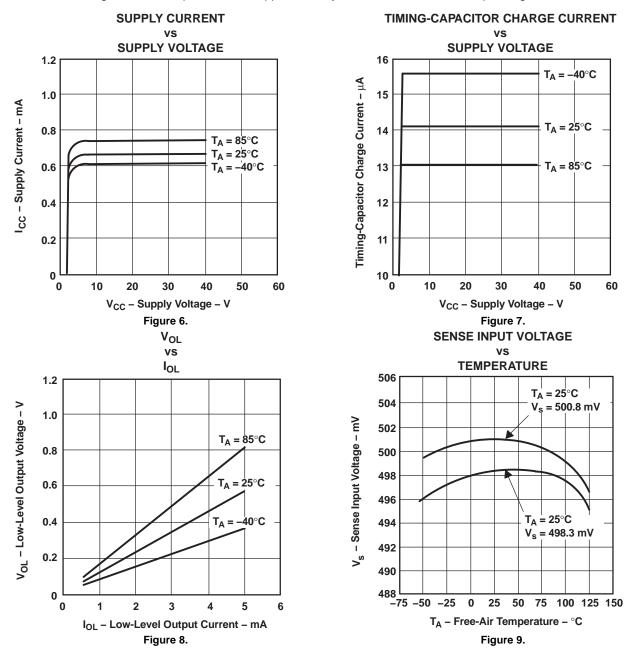
Figure 5. Switching Characteristics Measurement Circuit

60



### **TYPICAL CHARACTERISTICS**

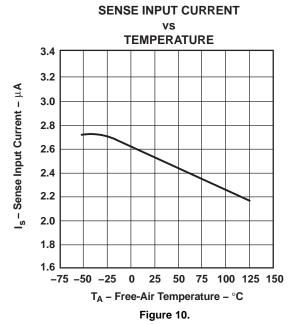
Data at high and low temperatures are applicable only within the recommended operating conditions.

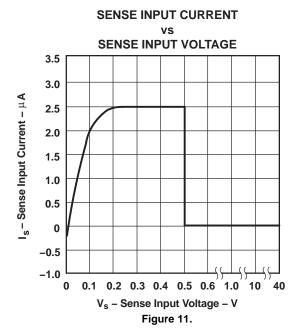




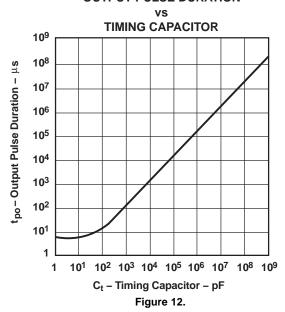
# **TYPICAL CHARACTERISTICS (continued)**

Data at high and low temperatures are applicable only within the recommended operating conditions.





#### **OUTPUT PULSE DURATION**





# **TYPICAL CHARACTERISTICS (continued)**

Data at high and low temperatures are applicable only within the recommended operating conditions.

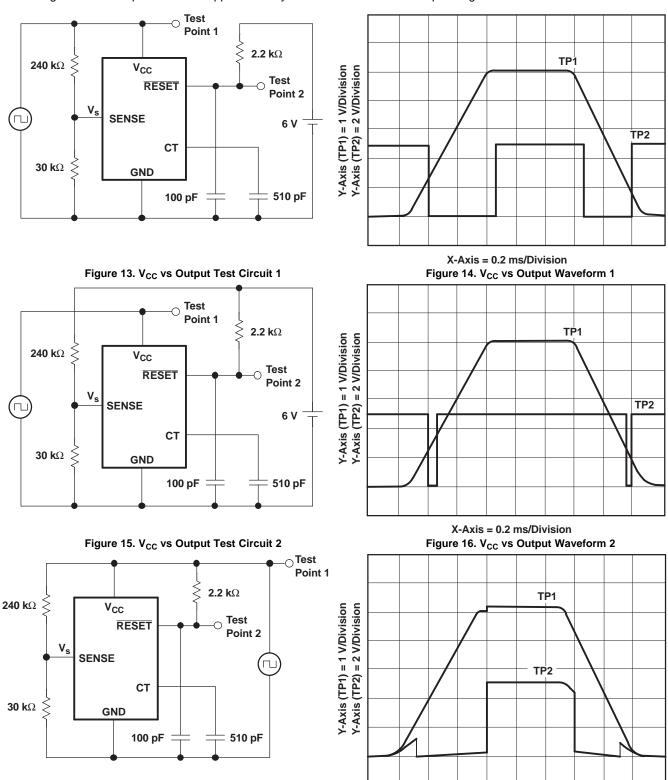


Figure 17. V<sub>CC</sub> vs Output Test Circuit 3

X-Axis = 0.2 ms/Division Figure 18. V<sub>CC</sub> vs Output Waveform 3



#### **DETAILED DESCRIPTION**

### Sense-Voltage Setting

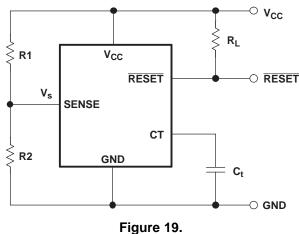
The SENSE terminal input voltage, Vs, of the TL7700 typically is 500 mV. By using two external resistors, the circuit designer can obtain any sense voltage over 500 mV. In Figure 19, the sensing voltage, Vs', is calculated as:

$$V_{s'} = V_s \times (R1 + R2)/R2$$

Where:

$$V_s = 500 \text{ mV typ at } T_A = 25^{\circ}\text{C}$$

At room temperature,  $V_s$  has a variation of 500 mV  $\pm$  5 mV. In the basic circuit shown in Figure 19, variations of  $[\pm 5 \pm (R1 + R2)/R2]$  mV are superimposed on  $V_s$ .



-

#### Sense-Voltage Hysteresis Setting

If the sense voltage  $(V_s)$  does not have hysteresis in it, and the voltage on the sensing line contains ripples, the resetting of TL7700 is unstable. Hysteresis is added to the sense voltage to prevent such problems. As shown in Figure 20, the hysteresis  $(V_{hvs})$  is added, and the value is determined as:

$$V_{hys} = I_s \times R1$$

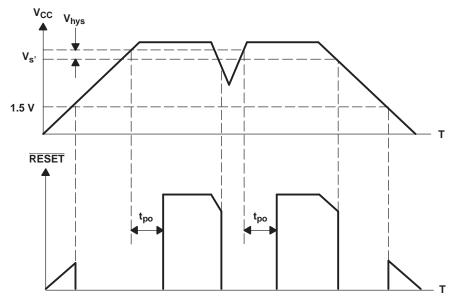
Where:

$$I_s = 2.5 \,\mu\text{A}$$
 typ at  $T_A = 25^{\circ}\text{C}$ 

At room temperature, Is has variations of 2.5 mA  $\pm$  0.5 mA. Therefore, in the circuit shown in Figure 19,  $V_{hys}$  has variations of ( $\pm$ 0.5  $\times$  R1) mV. In circuit design, it is necessary to consider the voltage-dividing resistor tolerance and temperature coefficient in addition to variations in  $V_{s}$  and  $V_{hys}$ .

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A. The sense voltage, V<sub>s'</sub>, is different from the SENSE terminal input voltage, V<sub>s</sub>. V<sub>s</sub> normally is 500 mV for triggering.

Figure 20. V<sub>CC</sub>-RESET Timing Chart

# **Output Pulse-Duration Setting**

Constant-current charging starts on the timing capacitor when the sensing-line voltage reaches the  $\frac{TL7700}{RESET}$  sense voltage. When the capacitor voltage exceeds the threshold level of the output drive comparator,  $\frac{RESET}{RESET}$  changes from a low to a high level. The output pulse duration is the time between the point when the sense-pin voltage exceeds the threshold level and the point when the  $\frac{RESET}{RESET}$  output changes from a low level to a high level. When the  $\frac{RESET}{RESET}$  output pulse duration,  $\frac{RESET}{RESET}$  output pulse duration  $\frac{RESET}{RESET}$  output pulse  $\frac{RESET}{RESET}$  output  $\frac{RESET}{RESET}$  o

$$t_{po} = C_t \times 105 \text{ seconds}$$

Where:

C<sub>t</sub> is the timing capacitor in farads

There is a limit on the device response speed. Even if  $C_t = 0$ ,  $t_{po}$  is not 0, but approximately 5  $\mu s$  to 10  $\mu s$ . Therefore, when the TL7700 is used as a comparator with hysteresis without connecting  $C_t$ , switching speeds  $(t_t/t_f, t_{po}/t_{pd},$  etc.) must be considered.







#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp (3)
TL7700CDGKR	PREVIEW	MSOP	DGK	8	2500	TBD	Call TI	Call TI
TL7700CDGKT	PREVIEW	MSOP	DGK	8	250	TBD	Call TI	Call TI
TL7700CP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TL7700CPE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TL7700CPSR	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL7700CPSRG4	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL7700CPW	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL7700CPWE4	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL7700CPWG4	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL7700CPWR	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL7700CPWRE4	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL7700CPWRG4	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>&</sup>lt;sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <a href="http://www.ti.com/productcontent">http://www.ti.com/productcontent</a> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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# **PACKAGE OPTION ADDENDUM**

5-Nov-2008

www.ti.com	5-Nov-2008
to Customer on an annual basis.	



### TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL7700CPSR	SO	PS	8	2000	330.0	16.4	8.2	6.6	2.5	12.0	16.0	Q1
TL7700CPWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1





\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TL7700CPSR	SO	PS	8	2000	346.0	346.0	33.0
TL7700CPWR	TSSOP	PW	8	2000	346.0	346.0	29.0

## PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

# DGK (S-PDSO-G8)

# PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
- E. Falls within JEDEC MO-187 variation AA, except interlead flash.





NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



### P (R-PDIP-T8)

#### PLASTIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001

For the latest package information, go to http://www.ti.com/sc/docs/package/pkg\_info.htm

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Military	www.ti.com/military
Optical Networking	www.ti.com/opticalnetwork
Security	www.ti.com/security
Telephony	www.ti.com/telephony
Video & Imaging	www.ti.com/video
Wireless	www.ti.com/wireless

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